

FQP7P06-VB Datasheet P-Channel 60-V (D-S) MOSFET

PRODUCT SUMMARY				
V _{DS}	-60	V		
R _{DS(on)} V _{GS} = 10 V	62	mΩ		
$R_{DS(on)}$ $V_{GS} = 4.5 \text{ V}$	74	mΩ		
I _D	-40	Α		
Configuration	Single			

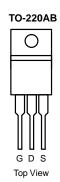
FEATURES

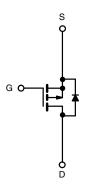
- TrenchFET® Power MOSFET
- 100 % UIS Tested



APPLICATIONS

Load Switch





P-Channel MOSFET

ABSOLUTE MAXIMUM RATINGS $T_C = 2$	25 °C, unless othe	rwise noted			
Parameter		Symbol	Limit	Unit	
Gate-Source Voltage		V _{GS}	± 20	V	
Continuous Drain Current (T _J = 175 °C)	T _C = 25 °C	I_	-40		
	T _C = 100 °C	I _D	-30		
Pulsed Drain Current		I _{DM}	- 90	Α	
Continuing Source Current (Diode Conduction)		I _S	- 30		
Avalanche Current		I _{AS}	- 28	1	
Single Pulse Avalanche Energy	L = 0.1 mH	E _{AS}	7.2	mJ	
Maximum Power Dissipation	T _C = 25 °C	P _D	60 ^a	w	
	T _A = 25 °C	r D	2 ^b]	
Operating Junction and Storage Temperature Range		T _J , T _{stg}	- 55 to 175	°C	

THERMAL RESISTANCE RATINGS						
Parameter		Symbol	Typical	Maximum	Unit	
hunghian ta Ambianto	t ≤ 10 sec	R _{thJA}	20	25		
Junction-to-Ambient ^D	Steady State		62	75	°C/W	
Junction-to-Case		R _{thJC}	5	6		

Notes:

- a. See SOA curve for voltage derating.
- b. Surface Mounted on 1" x 1" FR-4 boad.



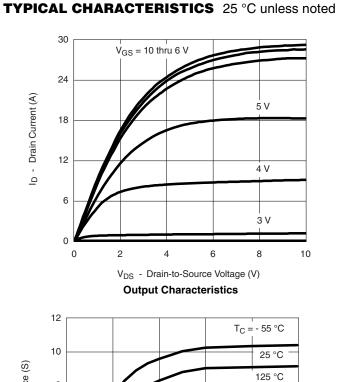
SPECIFICATIONS T _J = 25			Min	Tuna	Mov	Hnit	
Parameter	Symbol	Test Conditions	Min	Typ ^a	Max	Unit	
Static		V 0.V I 050 A		1	<u> </u>		
Drain-Source Breakdown Voltage	V _{(BR)DSS}	$V_{GS} = 0 \text{ V, } I_D = -250 \mu\text{A}$	- 60			V	
Gate Threshold Voltage	V _{GS(th)}	$V_{DS} = V_{GS}, I_{D} = -250 \mu A$	- 1.0		- 3.0		
Gate-Body Leakage	I _{GSS}	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 20 \text{ V}$			± 100	nA	
Zero Gate Voltage Drain Current		V _{DS} = - 60 V, V _{GS} = 0 V			- 1		
	I _{DSS}	V _{DS} = - 60 V, V _{GS} = 0 V, T _J = 125 °C			- 50	μΑ	
		$V_{DS} = -60 \text{ V}, V_{GS} = 0 \text{ V}, T_{J} = 175 \text{ °C}$			- 150		
On-State Drain Current ^b	I _{D(on)}	V _{DS} = - 5 V, V _{GS} = - 10 V	- 10			Α	
		V _{GS} = - 10 V, I _D = - 5 A		62			
5	_	V _{GS} = - 10 V, I _D = - 5 A, T _J = 125 °C		80		_	
Drain-Source On-State Resistance ^D	r _{DS(on)}	V _{GS} = - 10 V, I _D = - 5 A, T _J = 175 °C		110		mΩ	
		V _{GS} = - 4.5 V, I _D = - 2 A		74			
Forward Transconductance ^b	9 _{fs}	V _{DS} = - 15 V, I _D = - 5 A		8		S	
Dynamic	ļ	· · · · · · · · · · · · · · · · · · ·		ļ	<u> </u>		
Input Capacitance	C _{iss}			1300		pF	
Output Capacitance	C _{oss}	$V_{DS} = -25 \text{ V}, V_{GS} = 0 \text{ V}, f = 1 \text{ MHz}$		120			
Reverse Transfer Capacitance	C _{rss}] [90			
Total Gate Charge	Q_g			13			
Gate-Source Charge	Q_{gs}	$V_{DS} = -30 \text{ V}, V_{GS} = -10 \text{ V}, I_{D} = -8.4 \text{ A}$		2.3		nC	
Gate-Drain Charge	Q_{gd}	1		3.2			
Gate Resistance	R_{g}	f = 1 MHz		8.0		Ω	
Turn-On Delay Time ^c	t _{d(on)}			5	10		
Rise Time ^c	t _r	$V_{DD} = -30 \text{ V}, R_L = 3.57 \Omega$		14	25		
Turn-Off Delay Time ^c	t _{d(off)}	$I_D \cong -8.4 \text{ A}, V_{GEN} = -10 \text{ V}, R_G = 2.5 \Omega$		15	25	ns	
Fall Time ^c	t _f	1		7	12		
Source-Drain Diode Ratings and Cha	racteristics	(T _C = 25 °C) ^b		1			
Pulsed Current	I _{SM}			- 20		Α	
Forward Voltage ^b	V_{SD}	I _F = - 2 A, V _{GS} = 0 V		- 0.9	- 1.3	V	
Reverse Recovery Time	t _{rr}			50	80	ns	
Reverse Recovery Time	Q _{rr}	- I _F = - 8 A, di/dt = 100 A/μs		80	120	nC	

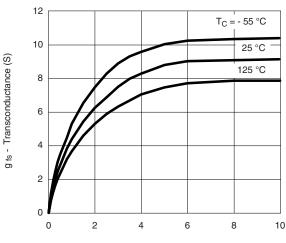
Notes:

- a. Guaranteed by design, not subject to production testing.
- b. Pulse test; pulse width \leq 300 $\mu s,$ duty cycle \leq 2 %.
- c. Independent of operating temperature.

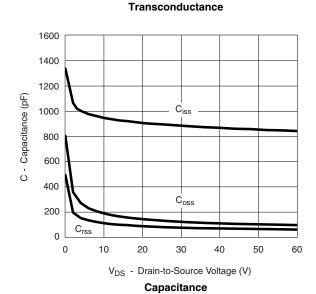
Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

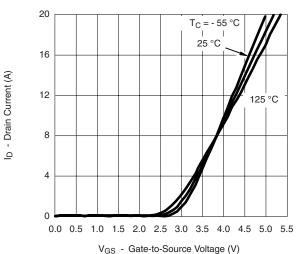




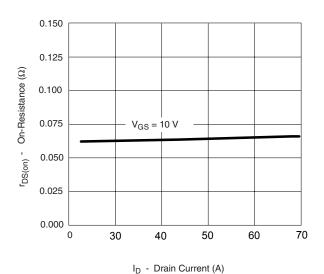


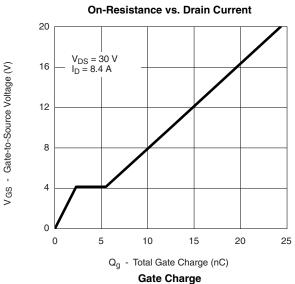
I_D - Drain Current (A)







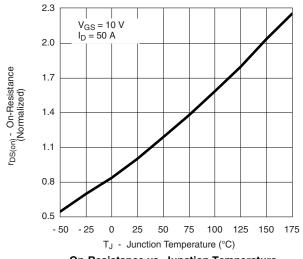


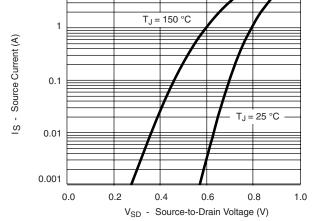


服务热线: 400-655-8788 3



TYPICAL CHARACTERISTICS 25 °C unless noted



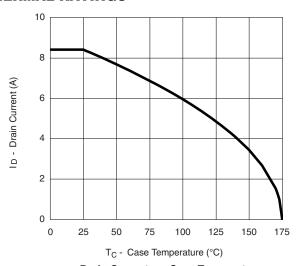


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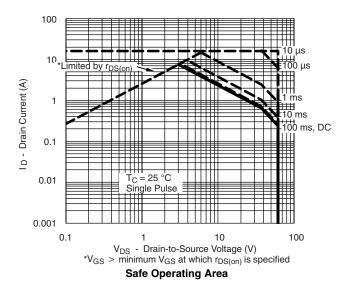
Source-Drain Diode Forward Voltage

On-Resistance vs. Junction Temperature

THERMAL RATINGS

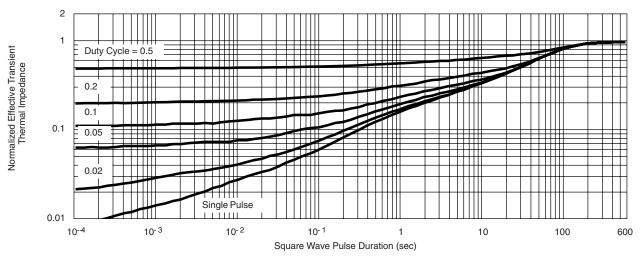


Drain Current vs. Case Temperature

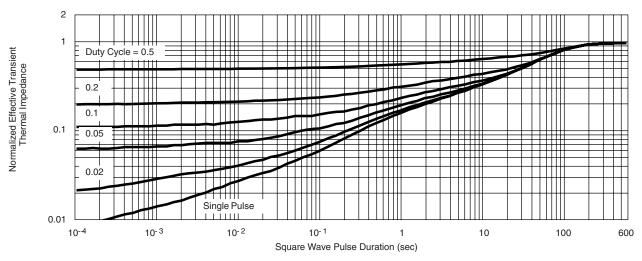




THERMAL RATINGS



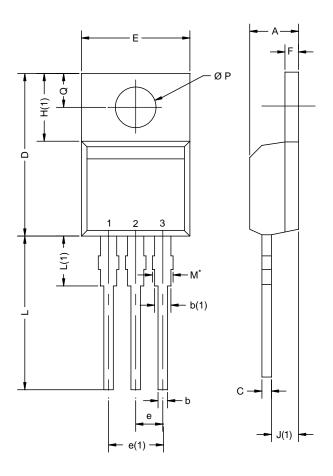
Normalized Thermal Transient Impedance, Junction-to-Ambient



Normalized Thermal Transient Impedance, Junction-to-Case



TO-220AB



	MILLIM	IETERS	INCHES		
DIM.	MIN.	MAX.	MIN.	MAX.	
Α	4.25	4.65	0.167	0.183	
b	0.69	1.01	0.027	0.040	
b(1)	1.20	1.73	0.047	0.068	
С	0.36	0.61	0.014	0.024	
D	14.85	15.49	0.585	0.610	
Е	10.04	10.51	0.395	0.414	
е	2.41	2.67	0.095	0.105	
e(1)	4.88	5.28	0.192	0.208	
F	1.14	1.40	0.045	0.055	
H(1)	6.09	6.48	0.240	0.255	
J(1)	2.41	2.92	0.095	0.115	
L	13.35	14.02	0.526	0.552	
L(1)	3.32	3.82	0.131	0.150	
ØР	3.54	3.94	0.139	0.155	
Q	2.60	3.00	0.102	0.118	

ECN: X12-0208-Rev. N, 08-Oct-12 DWG: 5471

Notes

 * M = 1.32 mm to 1.62 mm (dimension including protrusion) Heatsink hole for HVM



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